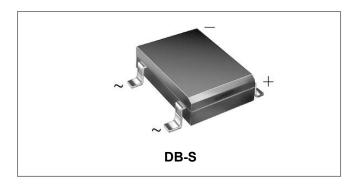




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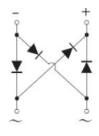
DB151S THRU DB157S SINGLE-PHASE GLASS PASSIVATED SILICON BRIDGE RECTIFIERS



Features

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: DB-S, molded plastic
- Terminals: plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting position: Any
- Lead Free: For RoHS / Lead Free Version,

Maximum Ratings @T_A=25°C unless otherwise specified

Single Phase half wave 60Hz, resistive or inductive load. For capacitive load current derate by 20%.

Characteristic	Symbol	DB 151S	DB 152S	DB 153S	DB 154S	DB 155S	DB 156S	DB 157S	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Average Forward Output Current (Note 1) @ T _c =100°C	I _{F(AV)}	1.5					A		
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	55				A			
I ² t Rating for Fusing (t < 8.3ms)	l²t	12.6				A ² s			

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Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	DB 151S	DB 152S	DB 153S	DB 154S	DB 155S	DB 156S	DB 157S	Units
Maximum Forward Voltage Drop* per Bridge Element @I _F =1.5A, T _J =25°C	V _F 1.0			V					
Peak Reverse Current*@T _A = 25°CAt Rated DC Blocking Voltage*@T _A = 125°C	I _R				5 100				μA
Typical Junction Capacitance (Note 2)	CJ				20				pF

* Pulse width < 300 μ s, duty cycle < 2%

Thermal-Mechanical Specifications @TA=25°C unless otherwise specified

Characteristic	Symbol	DB 151S	DB 152S	DB 153S	DB 154S	DB 155S	DB 156S	DB 157S	Units
Typical Thermal Resistance Junction to Ambient	R _{0JA}	R _{0JA} 40			°C/W				
Typical Thermal Resistance Junction to Lead	R _{ejl}	15							°C/W
Operating Junction and Storage Temperature T		-55 to + 150							°C

Note: 1. Mounted on glass epoxy PC board with 1.3mm² solder pad.

2. Measured at 1.0 MHZ and applied reverse voltage of 4.0 VDC

Ratings and Characteristics Curves

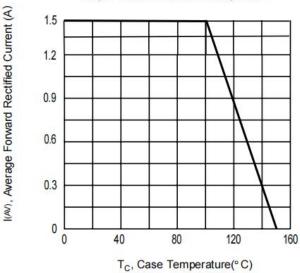
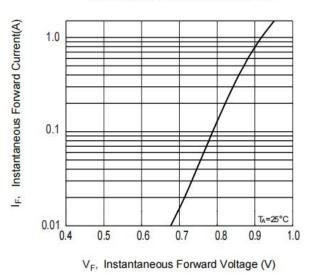


Fig. 1 Output Current Derating Curve

Fig. 2 Typical Forward Characteristics



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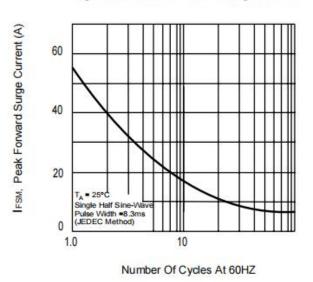
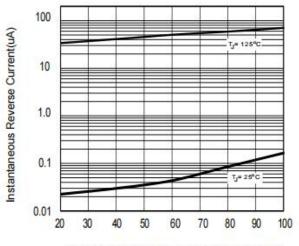


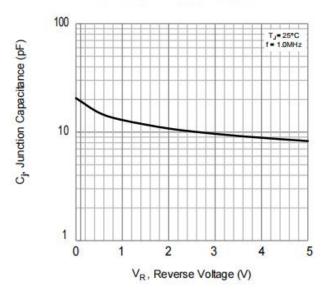
Fig.3 Maximum Peak Forward Surge Current

Fig.4 Typical Reverse Characteristics



Percent Of Rated Peak Reverse Voltage(%)

Fig. 5 Typical Junction Capacitance



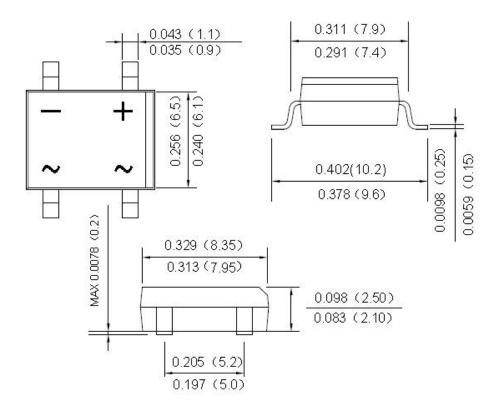


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Mechanical Dimensions DB-S(Inches/Millimeters)





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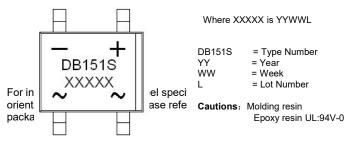
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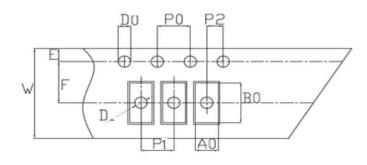
Ordering Information

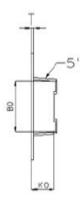
Device	Package	Plating	Shipping
DB151S THRU DB157S	DB-S (Pb-Free)	Pure Sn	1500pcs / reel
DB151STR THRU DB157STR	DB-S (Pb-Free)	Pure Sn	1500pcs / reel

Marking Diagram



Carrier Tape Specification DB-S





SYMBOL	Millimeters						
STMBOL	Min.	Max.					
A0	8.65	8.95					
B0	10.31	10.51					
D0	1.50	1.60					
D1	1.40	1.60					
P0	3.90	4.10					
P1	11.90	12.10					
P2	1.90	2.10					
E	1.65	1.85					
K0	3.21	3.41					
F	7.40	7.60					
W	15.70	16.30					
Т	0.30	0.40					
10P0	39.80	40.20					



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